

Product/process change notification

PCN N° 2022-108-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Introduction of an additional wafer production location at Infineon Technologies Austria AG Villach, Austria for CoolMOS TM CFD7 600V products in PG-TO247-3 package

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-10-05
- Infineon aligns with the widely recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress. We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance. For further details, please visit our website: https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

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restricted



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►	Products affected	Please refer to attached affected product list	1_cip22108_a
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Detailed change information

Subject	Introduction of an additional wafer production location at Infineon Technologies Austria AG, Villach, Austria for CoolMOS TM CFD7 600V product in PG-TO247-3 package. Additional capacity to ensure continuity of supply and enable flexible manufacturing.			
Reason				
Description	Old	New		
	 Infineon Technologies Dresden GmbH, Dresden, Germany 	 Infineon Technologies Dresden GmbH, Dresden, Germany or 		
		 Infineon Technologies Austria AG, Villach, Austria 		
 Product identification 	Traceability via Baunumber, Lotnumber; external traceability Product Barcode Label			
Impact of change	NO change on electrical and thermal performance NO impact on the device reliability as proven via product qualification NO impact on the electrical parameters and device process ability at customer end			
 Attachments 	1_cip22108_a affected pr 2_cip22108_a Qualification	oduct list on test report		



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Time schedule

- Final qualification report
- First samples available

on request

2023-03-31

available

Intended start of delivery

If you have any questions, please do not hesitate to contact your local sales office

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Introduction of an additional wafer production location at Infineon Technologies Austria AG Villach, Austria for CoolMOS TM CFD7 600V products in PG-TO247-3

infineon

Affected products sold to DIGI-KEY (4002348)

Sales name	SP number	OPN	Package	Customer part number
IPW60R018CFD7	SP001715618	IPW60R018CFD7XKSA1	PG-TO247-3	IPW60R018CFD7XKSA1
IPW60R024CFD7	SP002621050	IPW60R024CFD7XKSA1	PG-TO247-3	IPW60R024CFD7XKSA1
IPW60R031CFD7	SP001617992	IPW60R031CFD7XKSA1	PG-TO247-3	IPW60R031CFD7XKSA1
IPW60R037CSFD	SP001927820	IPW60R037CSFDXKSA1	PG-TO247-3	IPW60R037CSFDXKSA1
IPW60R040CFD7	SP001686068	IPW60R040CFD7XKSA1	PG-TO247-3	IPW60R040CFD7XKSA1
IPW60R055CFD7	SP001686062	IPW60R055CFD7XKSA1	PG-TO247-3	IPW60R055CFD7XKSA1
IPW60R070CFD7	SP001617990	IPW60R070CFD7XKSA1	PG-TO247-3	IPW60R070CFD7XKSA1
IPW60R090CFD7	SP001686056	IPW60R090CFD7XKSA1	PG-TO247-3	IPW60R090CFD7XKSA1
IPW60R105CFD7	SP001715628	IPW60R105CFD7XKSA1	PG-TO247-3	IPW60R105CFD7XKSA1
IPW60R125CFD7	SP001686040	IPW60R125CFD7XKSA1	PG-TO247-3	IPW60R125CFD7XKSA1
IPW60R145CFD7	SP001715654	IPW60R145CFD7XKSA1	PG-TO247-3	IPW60R145CFD7XKSA1
IPW60R170CFD7	SP001617988	IPW60R170CFD7XKSA1	PG-TO247-3	IPW60R170CFD7XKSA1

Qualification Test Report



PCN N° 2022-108-A Introduction of an additional wafer production location at Infineon Technologies Austria AG Villach, Austria for CoolMOS[™] CFD7 600V products in PG-TO247-3 package

Reason for choosing the following test vehicles:

IPW60R018CFD7 IPW60R031CFD7 IPW60R170CFD7	CFD7 600V technology in TO247, big chip of family qualification ; THD CFD7 600V technology in TO247, medium chip of family qualification ; THD CFD7 600V technology in TO247, small chip of family qualification ; THD
Scope of qualification:	All CoolMOS [™] CFD7 600V products in TO247-3 produced at Infineon Technologies Villach; Austria
Assessment of Q-Results:	pass industrial grade according to JEDEC

Stress test	Abbreviation	Test conditions	Readout	IPW60R018CFD7	IPW60R031CFD7	IPW60R170CFD7
				fails / stressed	fails / stressed	fails / stressed
Temperature Cycling JESD22-A104	TC*	- 55°C - +150°C	1000 cyc	0 / 77	0 / 77	0 / 77
Unbiased Temperature/Humidity JESD22-A118	UHAST*	Ta = 130°C, RH = 85%	96 h	0 / 77	0 / 77	0 / 77
High Humidity High Temp. Reverse Bias JESD22-A101	H3TRB*	T = 85°C RH = 85% V = 100 V	1000 h	0 / 77	0 / 77	0 / 77
High Temperature Reverse Bias JESD22-A108	HTRB*	Ta ≥ 150°C V ≥ 80% Vdss max	1000 h	0 / 77	0 / 77	0 / 77
High Temperature Gate stress JESD22-A108	HTGS*	Ta = 150°C Vg = ±20 V	1000 h	0 / 77	0 / 77	0 / 77
Intermitted Operational Life Test MIL-STD 750/Meth.1037	IOL*	Delta T = 100 K	15000 cyc	0 / 77	0 / 77	0 / 77